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PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
PO-HAO TSAI	12/24/2018
SHIH-TING HUNG	12/25/2018
SHIN-PUU JENG	12/25/2018
TECHI WONG	12/24/2018

RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.
Street Address:	NO. 8, LI-HSIN RD. 6
Internal Address:	HSINCHU SCIENCE PARK
City:	HSINCHU
State/Country:	TAIWAN
Postal Code:	300-78

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16242311

CORRESPONDENCE DATA

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Address Line 2: SUITE 100E

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ATTORNEY DOCKET NUMBER:	0941-3837PUS2
NAME OF SUBMITTER:	SPENCER GARTH
SIGNATURE:	/spencer garth/
DATE SIGNED:	01/08/2019

Total Attachments: 2

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ASSIGNMENT

WHEREAS, Po-Hao TSAI, Shih-Ting HUNG, Shin-Puu JENG and Techi WONG hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: CHIP PACKAGE STRUCTURE AND METHOD FOR FORMING THE SAME

***************************************		***************************************		
Filed: 1	January 8 2019	Serial No.	16/242 311	
Theresees	y December 24, 2018 an	1D 1 05 001	10	
executed on	. December 24, 2010 an	ia December 23. 201	18	~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~

WHEREAS, <u>Taiwan Semiconductor Manufacturing Co.</u>, <u>Ltd.</u>, of <u>No. 8, Li-Hsin Rd. 6, Hsinchu Science Park</u>, <u>Hsinchu 300-78</u>, <u>Taiwan R.O.C.</u>, hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

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ASSIGNMENT

Dec. 24, 20/8	Po How TS an
Date	Name: Po-Hao TSAI
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2018.12,25	
Date	Name: Shin-Puu JENG

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RECORDED: 01/09/2019

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